



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SOT-23



Pin Definition:

1. Gate
2. Source
3. Drain

Key Parameter Performance

Parameter	Value	Unit
V_{DS}	100	V
$R_{DS(on)}$ (max)	250	mΩ
Q_g	11.1	nC

Features

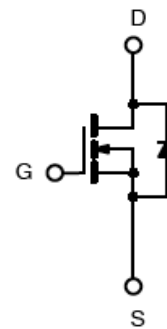
- Low $R_{DS(on)}$ 250mΩ (Max.)
- Low gate charge typical @ 11.1nC (Typ.)
- High performance trench technology

Ordering Information

Part No.	Package	Packing
TSM2328CX RFG	SOT-23	3Kpcs / 7" Reel

Note: "G" denotes for Halogen- and Antimony-free as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

Block Diagram



N-Channel MOSFET

Absolute Maximum Rating ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	1.5	A
Pulsed Drain Current (Note 1)	I_{DM}	6	A
Continuous Source Current (Diode Conduction)	I_S	0.6	A
Total Power Dissipation @ $T_A = 25^{\circ}\text{C}$	P_D	1.38	W
Operating Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^{\circ}\text{C}$

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Foot	$R\theta_{JF}$	55	$^{\circ}\text{C/W}$
Thermal Resistance - Junction to Ambient	$R\theta_{JA}$	100	$^{\circ}\text{C/W}$

Electrical Specifications ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

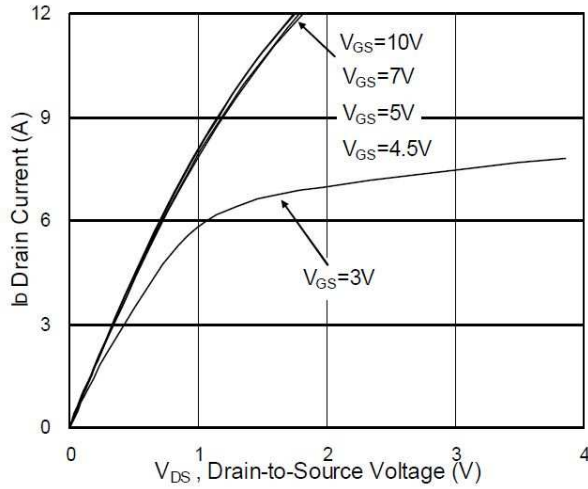
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	100	--	--	V
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 1.5A$	$R_{DS(ON)}$	--	--	250	mΩ
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	1.0	--	2.5	V
Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$	I_{DSS}	--	--	1	μA
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	--	--	±100	nA
On-State Drain Current	$V_{DS} = 5V, V_{GS} = 10V$	$I_{D(ON)}$	6	--	--	A
Forward Transfer Conductance	$V_{DS} = 15V, I_D = 1.5A$	g_{fs}	--	4	--	S
Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$	V_{SD}	--	1.2	--	V
Dynamic (Note 2)						
Total Gate Charge	$V_{DS} = 80V, I_D = 1.5A,$ $V_{GS} = 5V$	Q_g	--	11.1	--	nC
Gate-Source Charge		Q_{gs}	--	4.4	--	
Gate-Drain Charge		Q_{gd}	--	3	--	
Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0MHz$	C_{iss}	--	975	--	pF
Output Capacitance		C_{oss}	--	38	--	
Reverse Transfer Capacitance		C_{rss}	--	27	--	
Switching (Note 3)						
Turn-On Delay Time	$V_{DD} = 30V, I_D = 1A,$ $V_{GEN} = 10V, R_L = 30\Omega,$ $R_G = 6\Omega$	$t_{d(on)}$	--	9	--	ns
Turn-On Rise Time		t_r	--	9.4	--	
Turn-Off Delay Time		$t_{d(off)}$	--	26.8	--	
Turn-Off Fall Time		t_f	--	2.6	--	

Note:

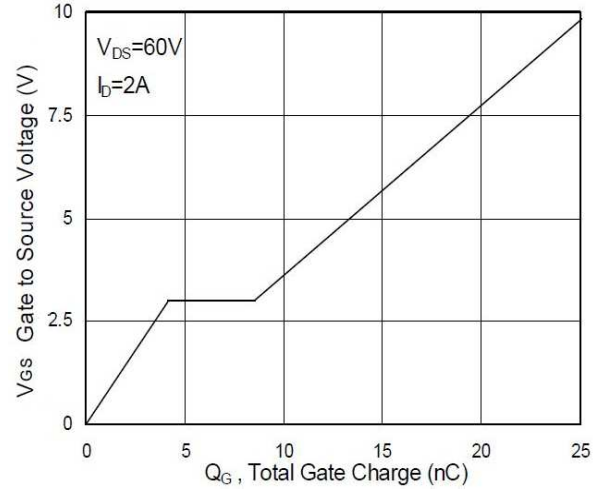
- Limited by maximum junction temperature.
- Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing

Electrical Characteristics Curve

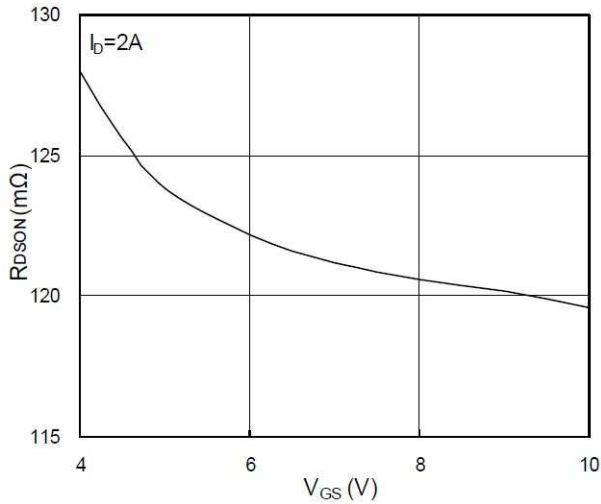
Typical Output Characteristic



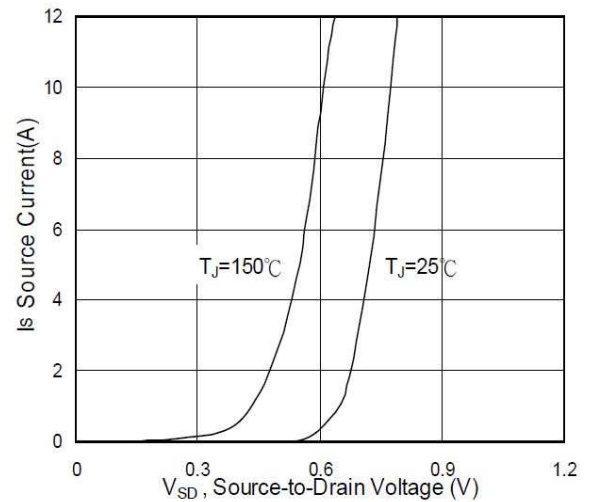
Gate Charge



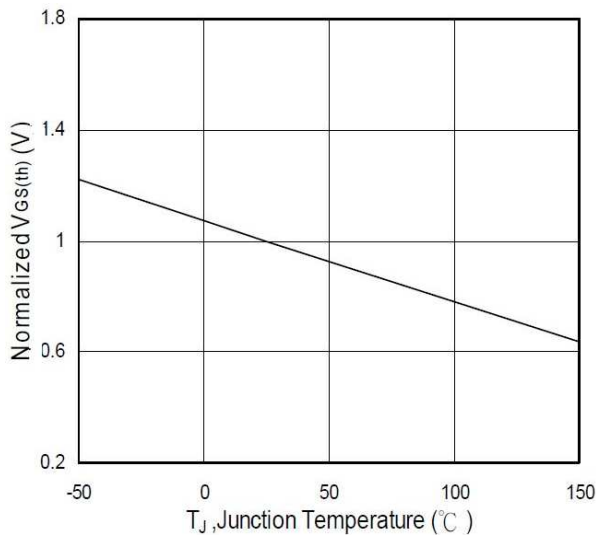
On-Resistance vs. Gate-Source Voltage



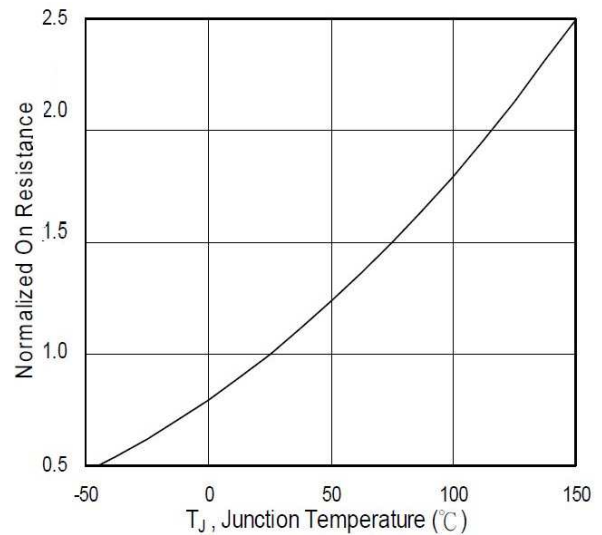
Source-Drain Diode Forward Voltage



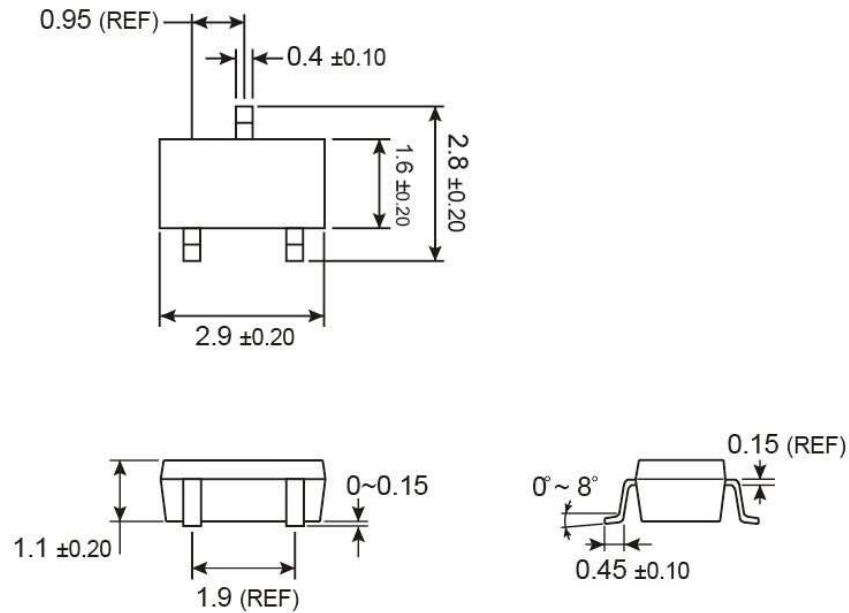
Normalized $V_{GS(th)}$ vs. Junction Temperature



Normalized $R_{DS(on)}$ vs. Junction Temperature

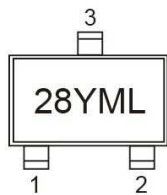


SOT-23 Mechanical Drawing



Unit: Millimeters

Marking Diagram



- Y** = Year Code
- M** = Month Code for Halogen Free Product
(**O**=Jan, **P**=Feb, **Q**=Mar, **R**=Apr, **S**=May, **T**=Jun, **U**=Jul, **V**=Aug, **W**=Sep, **X**=Oct, **Y**=Nov, **Z**=Dec)
- L** = Lot Code

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